

# **Smart Ticketing Alliance - Certification Working Group**



# STA Contactless Interface Certification for Public Transport Products Implementation Conformance Statement (ICS) for PICC



## **REVISION LIST**

Version	Date	Modifications
V1.0	13/12/2017	First public version for PICC and PCD
V2.0	06/07/2018	Separation in two different documents: one for PCD and this document for PICC Version applicable for PICC testing in accordance with CEN/TS 16794:2017
V2.1	16/11/2018	Editorial changes and correction of some mistakes
V2.2	16/06/2020	Editorial update on the item [PICC3.1]  The information about a previous certification shall be published in the certification letter.
V2.3	23/11/2022	The item "[PICC1.9] Type of card body structure" shall be published in the certification letter.
V3.0	17/11/2022	Version applicable for PICC testing in accordance with ISO/IEC TS 24192:2021  Release Candidate version subject to adjustments post round robin tests campaign with accredited Test Laboratories
V3.1	09/07/2024	Editorial changes
V3.2	07/10/2024	The version 2.3 has been added in the revision list.



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# 1 Scope

This document contains the Implementation Conformance Statement (ICS) for STA Contactless Interface Certification for Public Transport products and is intended for vendors submitting a PT object for certification.

Please note that ICS data with (\*) will be published in the certification letter issued by the STA Certification Body.



#### **2** Certification Stakeholders

## a. Vendor

Vendor identification				
Company name:	Company name: Click here to enter text.			
Main contact				
Contact name:	Click here to enter text.			
Address:	Click here to enter text.			
Telephone:	Click here to enter text.			
Email address:	Click here to enter text.			

# **b.** Test Laboratory

Test Laboratory identification			
Company name:	Company name: Click here to enter text.		
Main contact			
Contact name: Click here to enter text.			
Address: Click here to enter text.			
Telephone: Click here to enter text.			
Email address: Click here to enter text.			

# c. Certification Body

Certification Body identification			
Company name:	Company name: Click here to enter text.		
Main contact			
Contact name: Click here to enter text.			
Address: Click here to enter text.			
Telephone: Click here to enter text.			
Email address: Click here to enter text.			



## 3 ICS for PT objects – PICC (information to publish)

This clause and the following set out the information that needs to be provided by the PT object vendor when filing a product validation request.

This ICS references the technical characteristics for PICC defined in Clause 11.4 of ISO/IEC TS 24192-1:2021.

# a. PICC Product Description

[PICC1] Administrative data

[PICC1.1] (*) Brand name: Click he	ere to enter	text.			
[PICC1.2] (*) Trade name: Click he	ere to enter	text.			
[PICC1.3a] (*) Hardware version: Cl	lick here to	enter text.			
[PICC1.3b] (*) Software version: Cli	ick here to e	enter text.			
[PICC1.4] (*) PICC features ISO/IEC	C 7816 cont	act interfa	ce (dual):	O Yes	O No
[PICC1.5] (*) IC manufacturer: Clic	ck here to e	nter text.			
[PICC1.6] (*) IC reference / size: C	lick here to	enter text.			
[PICC1.9] (*) Type of card body str	ructure: Clic	ck here to e	enter text.		
The PICC is based on a STA certified PICC	C (*):	O Yes	O No		
If yes STA PICC certificate number (*): C	lick here to	enter text.			
If yes rationale to justify the delta-certif	ication (*):	Click here	to enter text.		
b. PICC General Te	echnical	Charact	eristics		
[PICC2] General technical characteristic	CS				
[PICC2.2] (*) Reference of PICC Ze	ero Point (ta	rget ID-ma	rked on sample	e or photo o	or diagram):
	Click	here to er	iter text.		



[PICC2.3] (*)	Operational temperature class supported as defined in Clause 11.2 of ISO/IEC TS 24192-1:2021:
	C Class A
	○ Class I
[PICC2.4] (*)	PICC class according to ISO/IEC 14443:
	C "Class 1" C "Class 2" C "Class 3"
	O Does not claim to meet the requirements of one particular PICC class
c. I	PICC Supported Options
[PICC3] General s	upported options
[PICC3.1] (*)	Supported communication signal interface(s) and protocol(s): Type A $\Box$ Type B $\Box$ Other: Click here to enter text.
[PICC4] Type A su	pported options (where applicable)
[PICC4.1] (*)	PCD to PICC bit rates supported: • fc/128 (~106 kbit/s)
	Other: Click here to enter text.
[PICC4.2] (*)	PICC to PCD bit rates supported:   fc/128 (~106 kbit/s)
	Other: Click here to enter text.
[PICC4.3] (*)	Only symmetrical bit rates supported:
[PICC4.10] (*)	S(PARAMETERS) support: Yes O No
[PICC5] Type B su	pported options (where applicable)
[PICC5.1] (*)	PCD to PICC bit rates supported: fc/128 (~106 kbit/s)
	Other: Click here to enter text.
[PICC5.2] (*)	PICC to PCD bit rates supported: <sup>●</sup> fc/128 (~106 kbit/s)
	Other: Click here to enter text.
[PICC5.3] (*)	Only symmetrical bit rates supported:   Yes   No
[PICC5.4] (*)	PUPI value: C Fixed number C Random number
[PICC5.9] (*)	Extended ATQB support:   Yes   No
	If yes, SFGI: Click here to enter text.
[PICC5.10] (*	S(PARAMETERS) support: Yes O No
[PICC5.11] (*	All AFIs are supported: Yes No
	If not, indicate all supported AFI(s): Click here to enter text.
[PICC5.12] (*	REQB/WUPB with N > 1 support: Yes No



## 4 ICS for PT Objects – PICC (information not to publish)

#### a. PICC Product Description

#### [PICC1] Administrative data

[PICC1.7]	Contactless antenna manufacturer: Click here to enter text.
[PICC1.8]	Contactless antenna model reference: Click here to enter text.
[PICC1.10]	Card body or PICC structure manufacturing site: Click here to enter text.
[PICC1.11]	IC embedding site (for dual PICC card): Click here to enter text.

Additional information concerning product description: Click here to enter text.

#### **b.** PICC General Technical Characteristics

[PICC2] General technical characteristics

[PICC2.1] Antenna diagram and position on the PT object under test (with dimensions):



Click here to enter text.

Additional information concerning technical characteristics: Click here to enter text.

## c. PICC Supported Options

[PICC4] Type A s	supporte	ed options (where applicable)	
[PICC4.4]	UID:	○ Single size (4 bytes) random	O Single size (4 bytes) fixed
		O Double Size (7 bytes)	
		○ Triple size (10 bytes)	
[PICC4.5]	FWI:	Click here to enter text.	
[PICC4.6]	[PICC4.6] SFGI: Click here to enter text.		
[PICC4.7]	FSCI:	Click here to enter text.	



	[PICC4.8]	CID support:	O Yes	O No			
	[PICC4.9]	NAD support:	O Yes	O No			
	[PICC4.11]	Frames with e	rror correct	ion support:	O Yes	O No	
[PIC	[PICC5] Type B supported options (where applicable)						
	[PICC5.5]	FWI: Click here	to enter te	ext.			
	[PICC5.6]	Maximum Fran	ne Size Cod	e in ATQB: Clic	ck here to e	nter text.	
	[PICC5.7]	CID support:	O Yes	O No			
	[PICC5.8]	NAD support:	O Yes	O No			
	[PICC5.13]	Frames with e	rror correct	ion support:	O Yes	O No	

Additional information concerning supported options: Click here to enter text.

#### d. PICC Test Parameters

[PICC6] Test parameters [PICC6.1a] TEST COMMAND1 APDU definition (hexadecimal value): Click here to enter text. [PICC6.1b] TEST\_COMMAND1 Answer to ADPU definition (hexadecimal value): Click here to enter text. Precondition sequence for TEST\_COMMAND1: Click here to enter text. [PICC6.1c] O Yes O No Is there a command which expects a response consisting of n chained I-blocks? TEST\_COMMAND2 APDU definition (hexadecimal value): Click here to enter text. [PICC6.2a] [PICC6.2b] TEST COMMAND2 Answer to ADPU definition (hexadecimal value): Click here to enter text. Precondition sequence for TEST\_COMMAND2: Click here to enter text. [PICC6.2c] O Yes O No Is there a command which needs more than FWT time for execution? [PICC6.3a] TEST COMMAND3 APDU definition (hexadecimal value): Click here to enter text. [PICC6.3b] TEST COMMAND3 Answer to ADPU definition (hexadecimal value): Click here to enter text. Precondition sequence for TEST\_COMMAND3: Click here to enter text. [PICC6.3c] [PICC6.4a] TEST\_COMMAND4 APDU definition (hexadecimal value): Click here to enter text. TEST COMMAND4 Answer to ADPU definition (hexadecimal value): Click here to enter text. [PICC6.4b] Precondition sequence for TEST\_COMMAND4: Click here to enter text. [PICC6.4c] [PICC6.5] TEST\_COMMAND\_SEQUENCE1: Click here to enter text.

Additional information concerning test parameters: Click here to enter text.

NOTE Usages of TEST\_COMMAND1, TEST\_COMMAND2, TEST\_COMMAND3 and TEST\_COMMAND4 for PICC tests are defined in ISO/IEC 10373-6.



If the PICC requires additional sequences to be ready to accept TEST\_COMMAND1, TEST\_COMMAND2, TEST\_COMMAND3 or TEST\_COMMAND4, those sequences shall be described in the precondition sequence fields.

TEST\_COMMAND\_SEQUENCE1 shall contain at minimum 2 APDUs with their respective expected answers. It shall also include application specific cryptographic functions, if applicable.



#### 5 Status of the ICS

Status:	To be validated					
ICS number¹: Click here to enter text.						
Date of validation by the Certification Body: Click here to select a date.						
Signature of the Certification Body's representative:						

- END OF DOCUMENT -

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<sup>&</sup>lt;sup>1</sup> For Certification Body use